

MOSFET

OptiMOS[™]5 Power-Transistor, 60 V

Features

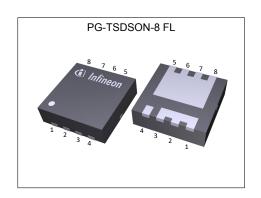
- Optimized for high performance SMPS, e.g. sync.rec.
- 100% avalanche testedSuperior thermal performance
- N-channel
- Pb-free lead plating : RoHS compliant
 Halogen-free according to EC61249-2-21

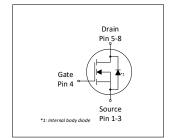
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit					
$V_{ extsf{DS}}$	60	V					
$R_{ extsf{DS(on)}, ext{max}}$	3.4	mΩ					
I _D	112	A					
Qoss	33	nC					
Q _G (0V4.5V)	20	nC					











Type / Ordering Code	Package	Marking	Related Links
ISZ034N06LM5	PG-TSDSON-8 FL	034N06L	-

OptiMOSTM5 Power-Transistor, 60 V



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OptiMOS[™]5 Power-Transistor, 60 V ISZ034N06LM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Comple of		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	112 79 19	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =60 °C/W ²⁾
Pulsed drain current ³⁾	$I_{D,pulse}$	-	-	448	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	121	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	83 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Dovementor	Values				Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	1.3	1.8	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	-	20	°C/W	-
Device on PCB, 6 cm² cooling area²)	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOSTM5 Power-Transistor, 60 V ISZ034N06LM5



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

	0		Value	s		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.1	1.7	2.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=36\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	2.9 3.5	3.4 4.2	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =10 A
Gate resistance ¹⁾	R _G	-	1.7	-	Ω	-
Transconductance	g fs	-	80	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$

Table 5 Dynamic characteristics

Dovometer	Crossball	Values			11	Nata / Tank Oam distant
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	2600	3500	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	550	730	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	25	33	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	7.6	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	4.2	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	27	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	8.0	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Cumbal	Values			11	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	6.6	-	nC	V_{DD} =30 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	4.2	-	nC	V _{DD} =30 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate to drain charge	Q_{gd}	-	6.2	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q _{sw}	-	8.6	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	20	27	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.5	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	40	53	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	36	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge	Qoss	-	33	-	nC	V _{DS} =30 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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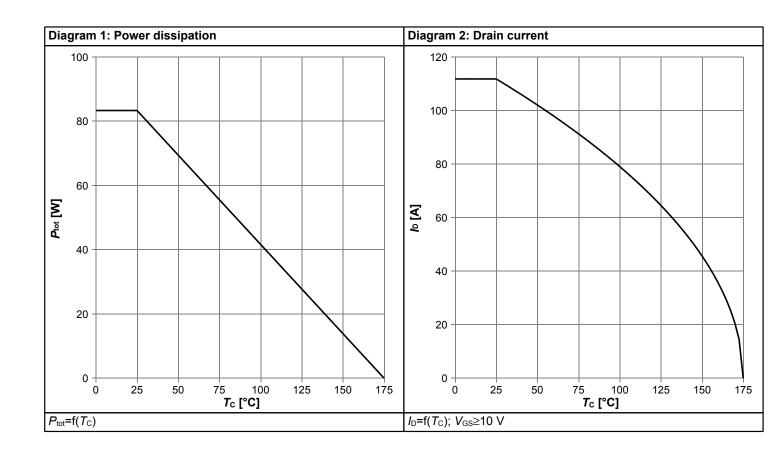


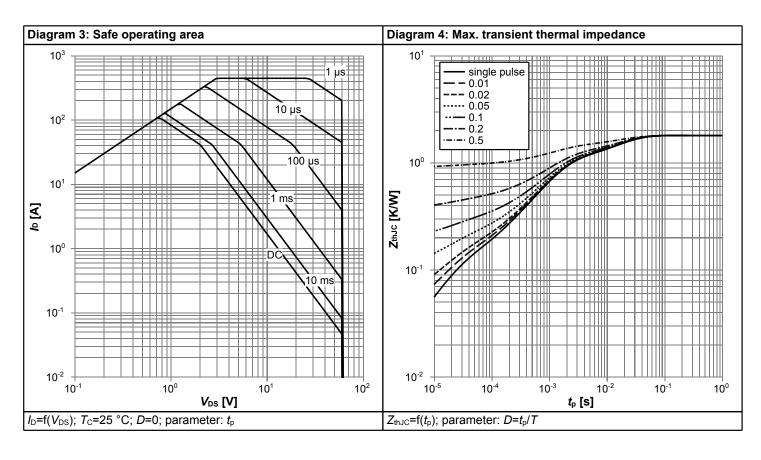
Table 7 Reverse diode

Davamatan	Cymphal		Values			Nata / Tank Canadiki an	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	73	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	448	Α	T _C =25 °C	
Diode forward voltage	V _{SD}	-	0.81	1.0	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C	
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	20	-	ns	V _R =30 V, I _F =20 A, di _F /dt=400 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	50	-	nC	V _R =30 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =400 A/μs	

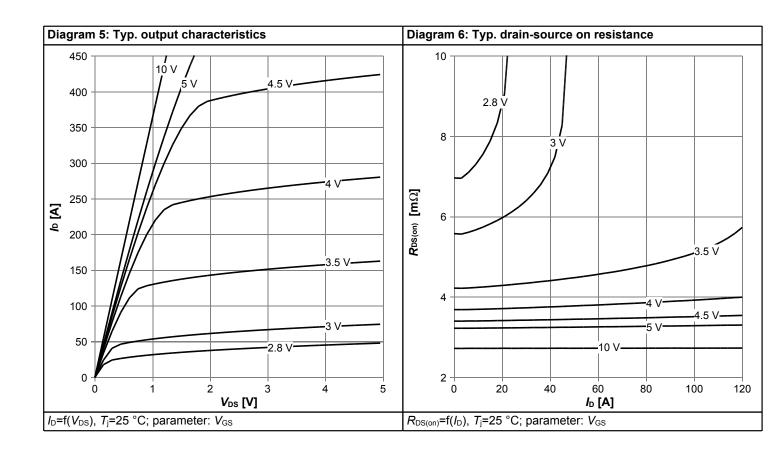


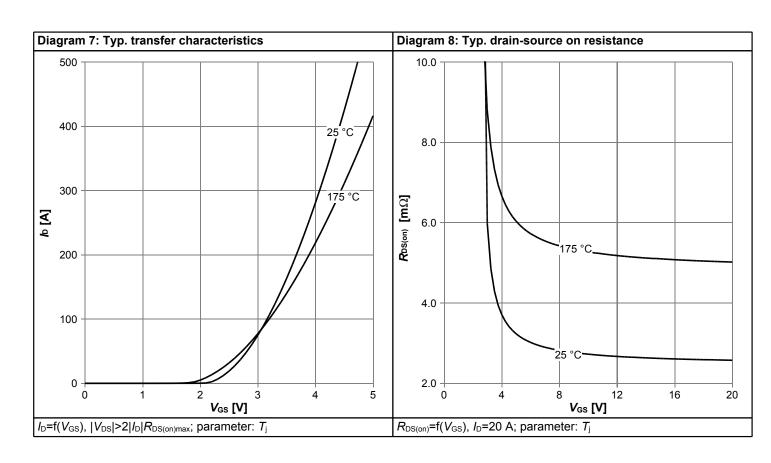
4 Electrical characteristics diagrams



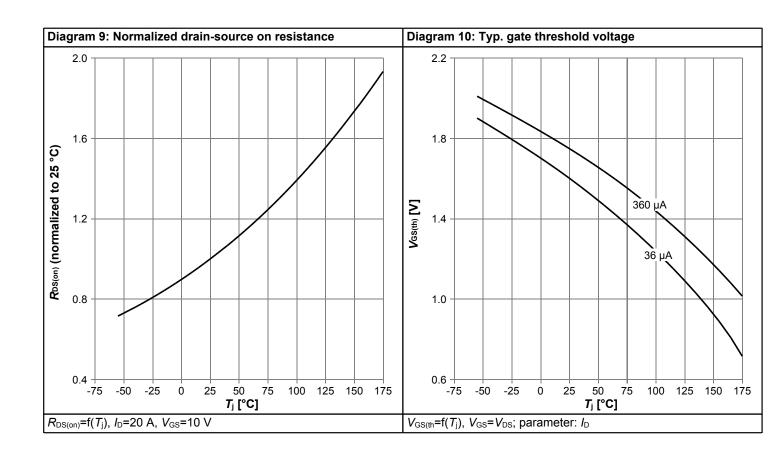


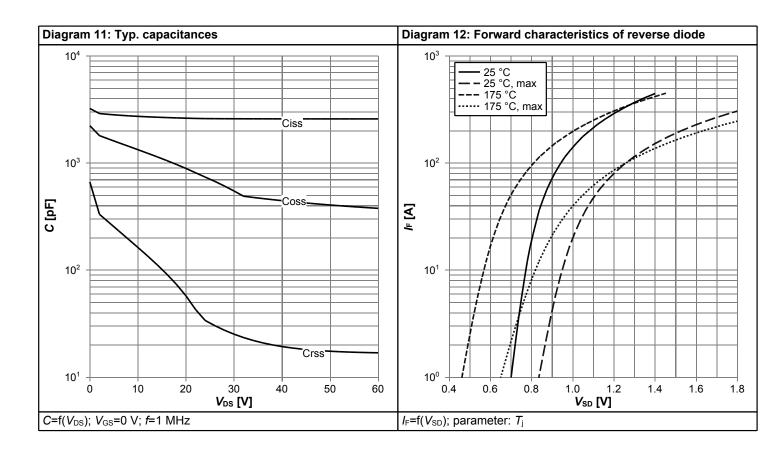




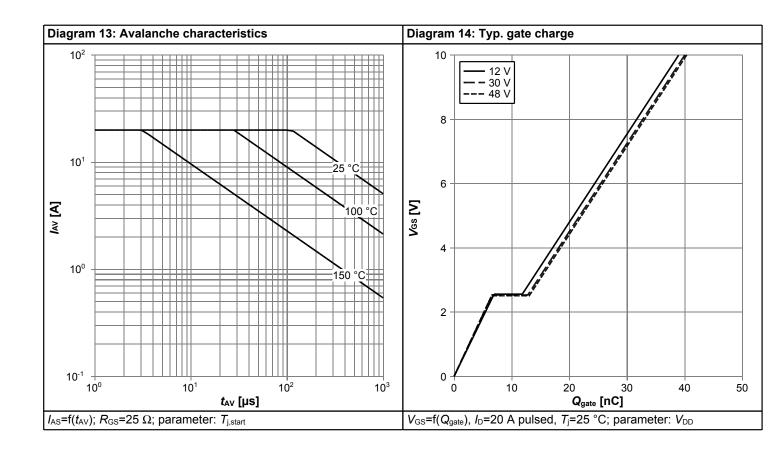


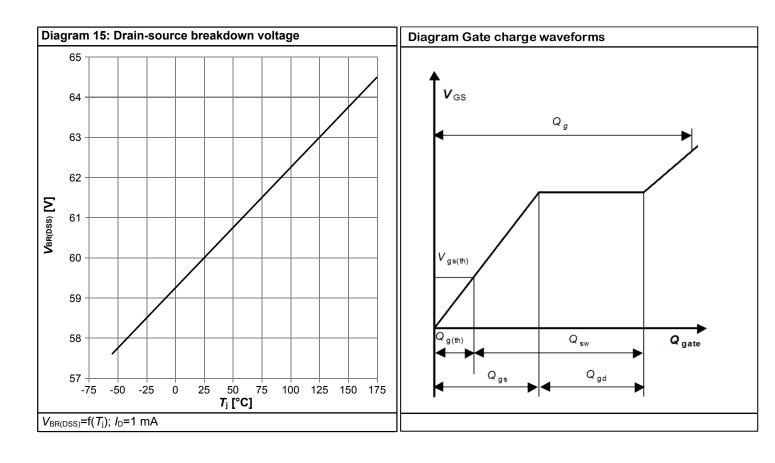






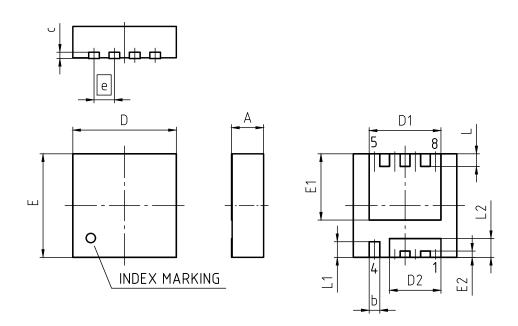








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSDS	SON-8-U03		
REVISION: 03	DATE:	20.10.2020		
DIMENSIONS	MILLIN	IETERS		
	MIN.	MAX.		
Α	0.90	1.10		
b	0.24	0.44		
С	(0.	20)		
D	3.20	3.40		
D1	2.19	2.39		
D2	1.54	1.74		
E	3.20	3.40		
E1	2.01	2.21		
E2	0.10	0.30		
е	0.65			
L	0.30	0.50		
L1	0.40	0.60		
L2	0.50	0.70		
aaa	0.0	06		

Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm

OptiMOSTM5 Power-Transistor, 60 V



Revision History

ISZ034N06LM5

Revision: 2021-03-12, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)				
2.0	2021-03-12	Release of final version				

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